

03-29-2004

HEET

10-20-03 10581-40

101475447

To the Honorable Assistant Secretary and
thereof.

s: Please record the attached original document



102706308

10/20/03 PTO 20 OCT 2003

1. Name of conveying party(ies):

Takeru YAMAKAWA; Yoshio OGINO, Yufu SAGARA, Kenji
MATSUDA, Akira NAYA, Toshifumi KIMURA
and Norikazu OTAKE

2. Name and address of receiving party(ies):

Name: Banyu Pharmaceutical Co., Ltd.

Address: 2-3, Nihombashi Honcho 2-chome, Chuo-ku
Tokyo 103-8416 Japan

Additional name(s) of conveying party(ies) attached? NO

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: October 10, 2003

Additional name(s) & address(es) attached? NO

4. Application number(s) or patent number(s):

101475447

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.
NEW, filed October 20, 2003B. Patent No.(s)
, issued

Additional numbers attached? NO

5. Name and address of party to whom correspondence
concerning document should be mailed:Name: WENDEROTH, LIND & PONACK, L.L.P.
Attn: Matthew Jacob, Esq.

Street Address: 2033 K Street, N.W., Suite 800

City: Washington, State: DC ZIP: 20006-1021

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). \$40.00

☒ Enclosed (Check No. 58281)
Authorized to be charged to deposit account

8. Deposit account number: 23-0975

(Attach duplicate copy of this page if paying by deposit account)

10/20/03

40.00 DP

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Matthew Jacob, Reg. No. 25,154
Name of Person Signing
SignatureOctober 20, 2003
Date

Total number of pages including cover sheet: 3

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ATTACHMENT D

PATENT

REEL: 015131 FRAME: 0694

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Takeru YAMAKAWA, Yoshio OGINO, Yufu SAGARA, Kenji MATSUDA,
Akira NAYA, Toshifumi KIMURA and Norikazu OTAKE, all
citizens of Japan,

Insert Name(s)
of Inventor(s)

the undersigned hereby sell(s) and assign(s) to

Insert Name(s)
of Assignee(s)

BANYU PHARMACEUTICAL CO., LTD., a Japanese corporation,

Address

of 2-3, Nihombashi Honcho 2-chome, Chuo-ku, TOKYO 103-8416
JAPAN

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

BENZIMIDAZOLONE DERIVATIVES

Title of
Invention

for which an application for patent in the United States has been executed by the undersigned on

Date of Signing
Application

October 10, 2003

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date October 10, 2003 Name of Inventor Yakaru Yamahawa
Date October 10, 2003 Name of Inventor Toshio Osino
Date October 10, 2003 Name of Inventor Yufu Sagara
Date October 10, 2003 Name of Inventor Kengo Matsuda
Date October 10, 2003 Name of Inventor Akira Naya
Date October 10, 2003 Name of Inventor Toshitumi Kimura
Date October 10, 2003 Name of Inventor Norikazu Otake
Date _____, Name of Inventor _____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Yusaku Tokai
Witness Klasao Nagashima

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____

Applicant Reference No. _____ Atty. Docket No. _____

Title of Invention _____